

APBD3224ESGC HIGH EFFICIENCY RED
SUPER BRIGHT GREEN

Features

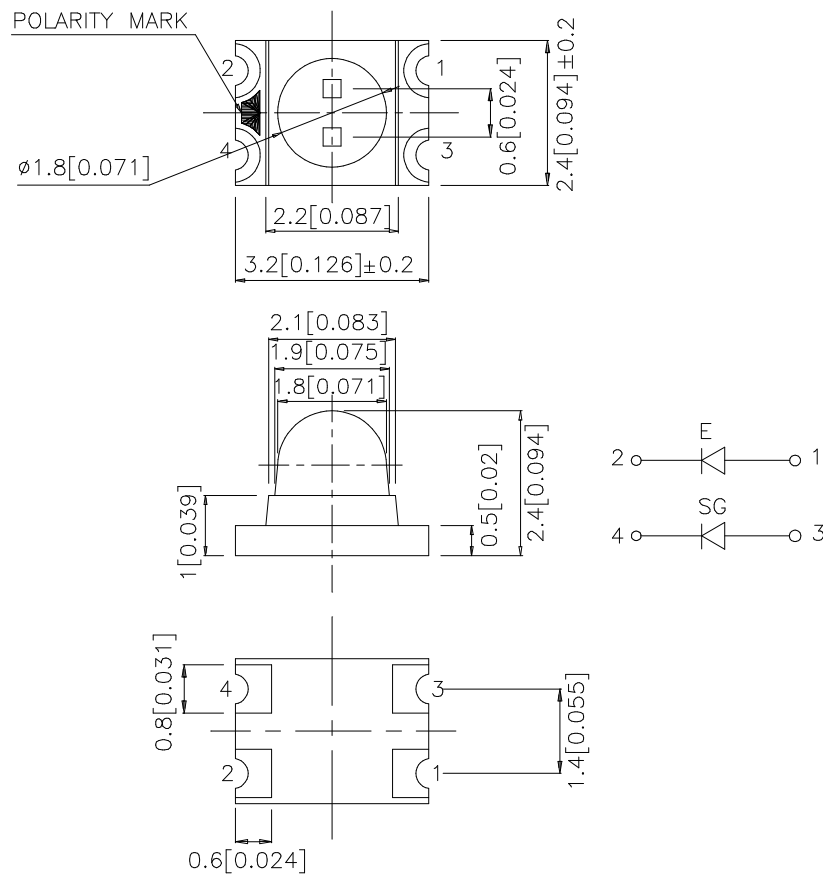
- 3.2x2.4mm SMT LED, 2.4mm THICKNESS.
- LOW POWER CONSUMPTION.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 1500PCS / REEL.

Description

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.1 (0.004") unless otherwise noted.
3. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20 mA		Viewing Angle
			Min.	Typ.	2θ1/2
APBD3224ESGC	HIGH EFFICIENCY RED (GaAsP/GaP)	WATER CLEAR	18	60	20°
	SUPER BRIGHT GREEN (GaP)		10	40	

Note:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Absolute Maximum Ratings at T_A=25°C

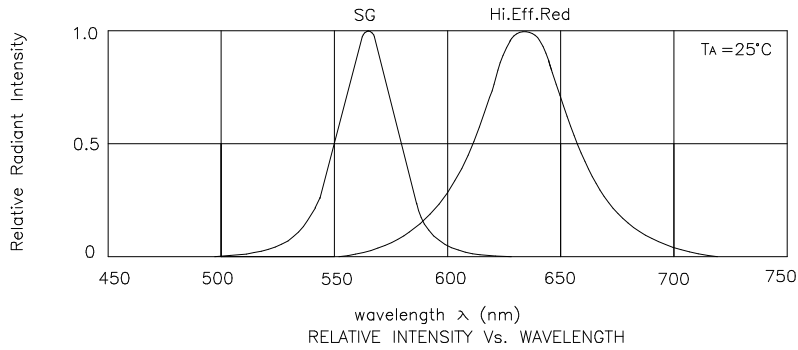
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ _{peak}	Peak Wavelength	High Efficiency Red Super Bright Green	627 565		nm	I _F =20mA
λ _D	Dominate Wavelength	High Efficiency Red Super Bright Green	625 568		nm	I _F =20mA
Δλ _{1/2}	Spectral Line Half-width	High Efficiency Red Super Bright Green	45 30		nm	I _F =20mA
C	Capacitance	High Efficiency Red Super Bright Green	15 15		pF	V _F =0V;f=1MHz
V _F	Forward Voltage	High Efficiency Red Super Bright Green	2.0 2.2	2.5 2.5	V	I _F =20mA
I _R	Reverse Current	All		10	uA	V _R = 5V

Absolute Maximum Ratings at T_A=25°C

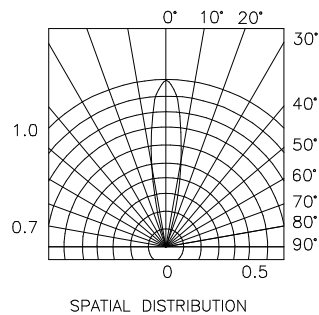
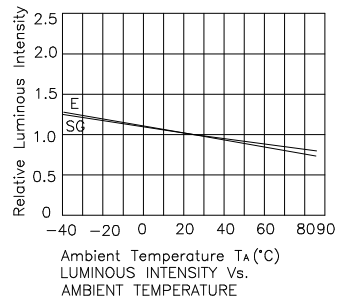
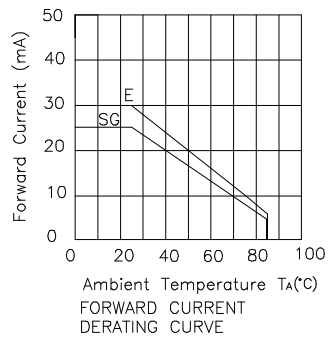
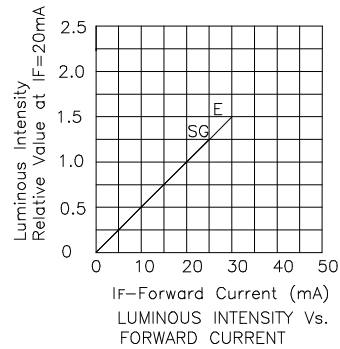
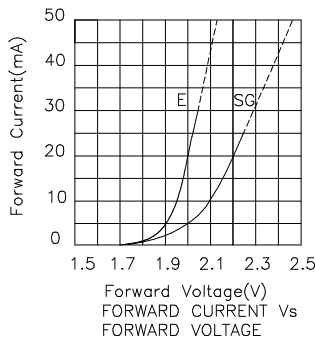
Parameter	High Efficiency Red	Super Bright Green	Units
Power dissipation	105	105	mW
DC Forward Current	30	25	mA
Peak Forward Current [1]	160	140	mA
Reverse Voltage	5	5	V
Operating/Storage Temperature	-40°C To +85°C		

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

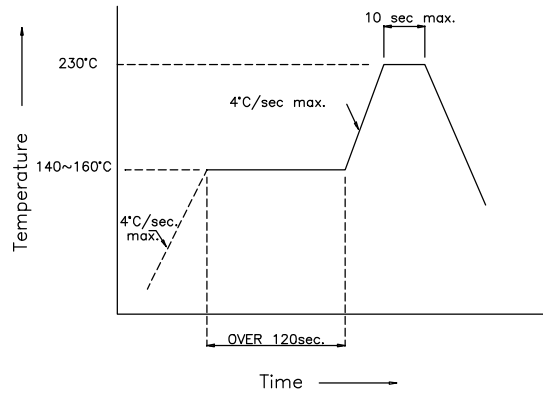


High Efficiency Red / Super Bright Green APBD3224ESGC

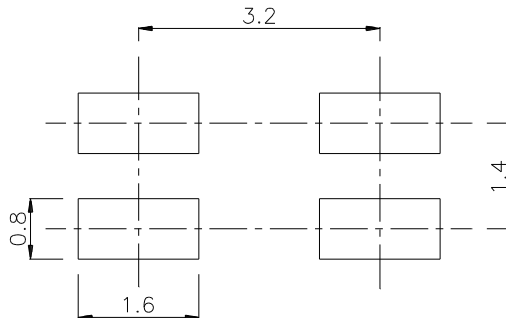


APBD3224ESGC SMT Reflow Soldering Instructions

Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units : mm)



Tape Specifications (Units : mm)

